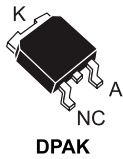
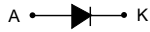


Automotive 650 V power Schottky silicon carbide diode



Features

- AEC-Q101 qualified
- No reverse recovery charge in application current range
- Switching behavior independent of temperature
- Recommended to PFC applications
- PPAP capable
- ECOPACK[®]2 compliant component

Description

The SiC diode is an ultra-high performance power Schottky diode. It is manufactured using a silicon carbide substrate. The wide band gap material allows the design of a Schottky diode structure with a 650 V rating. Due to the Schottky construction, no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

Especially suited for use in PFC applications, this ST SiC diode will boost performance in hard switching conditions.

Product status	
STPSC10H065BY-TR	
Product summary	
Symbol	Value
$I_{F(AV)}$	10 A
V_{RRM}	650 V
$T_{j(max.)}$	175 °C

1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage	$T_j = -40\text{ °C to } +175\text{ °C}$	650	V
$I_{F(RMS)}$	Forward rms current		22	A
$I_{F(AV)}$	Average forward current	$T_c = 140\text{ °C}^{(1)}$, DC	10	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10\text{ ms sinusoidal}$, $T_c = 25\text{ °C}$	90	A
		$t_p = 10\text{ ms sinusoidal}$, $T_c = 125\text{ °C}$	80	
		$t_p = 10\text{ }\mu\text{s square}$, $T_c = 25\text{ °C}$	470	
I_{FRM}	Repetitive peak forward current	$T_c = 140\text{ °C}^{(1)}$, $T_j = 175\text{ °C}$, $\delta = 0.1$	42	A
T_{stg}	Storage temperature range		-55 to +175	°C
T_j	Operating junction temperature range ⁽²⁾		-40 to +175	°C

1. Value based on $R_{th(j-c)}$ max.

2. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal parameters

Symbol	Parameter	Typ. value	Max. value	Unit
$R_{th(j-c)}$	Junction to case	1.25	1.5	°C/W

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
		T_j	V_R				
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-	9	100	μA
		$T_j = 150\text{ °C}$		-	85	425	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 10\text{ A}$	-	1.45	1.65	V
		$T_j = 150\text{ °C}$		-	1.7	2.05	

1. $t_p = 10\text{ ms}$, $\delta < 2\%$

2. $t_p = 500\text{ }\mu\text{s}$, $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

$$P = 0.972 \times I_{F(AV)} + 0.108 \times I_{F(RMS)}^2$$

Table 4. Dynamic electrical characteristics

Symbol	Parameter	Test conditions	Typ.	Unit
$Q_{cj}^{(1)}$	Total capacitive charge	$V_R = 400\text{ V}$	28.5	nC
C_j	Total capacitance	$V_R = 0\text{ V}$, $T_c = 25\text{ °C}$, $F = 1\text{ MHz}$	480	pF
		$V_R = 400\text{ V}$, $T_c = 25\text{ °C}$, $F = 1\text{ MHz}$	48	

1. Most accurate value for the capacitive charge: $Q_{cj} = \int_0^{V_{OUT}} c_j(V_R) \times dV_R$

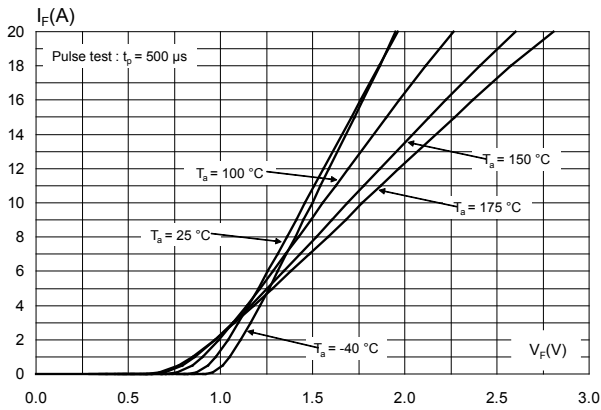
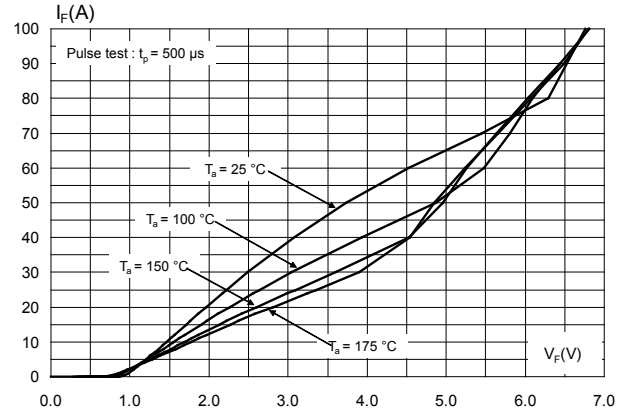
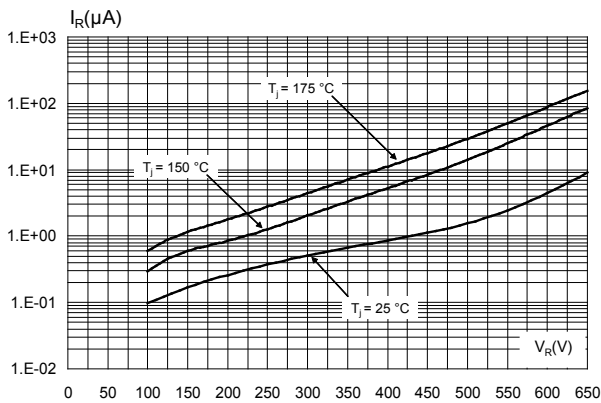
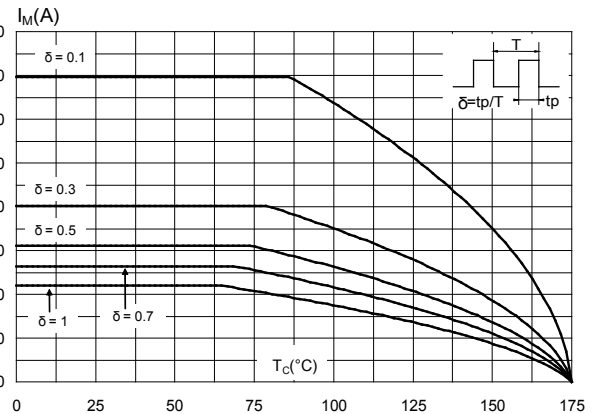
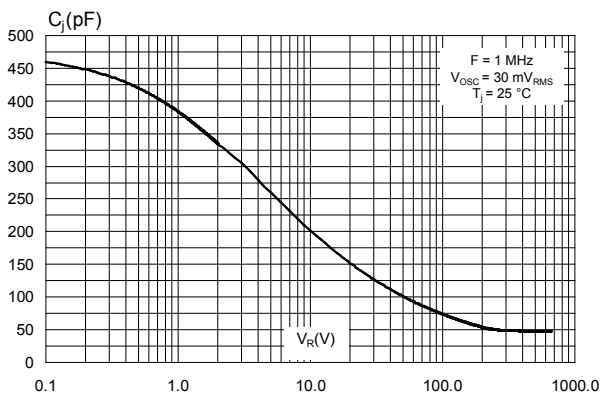
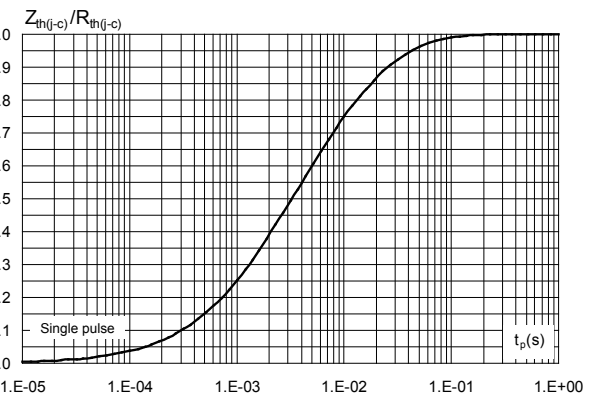
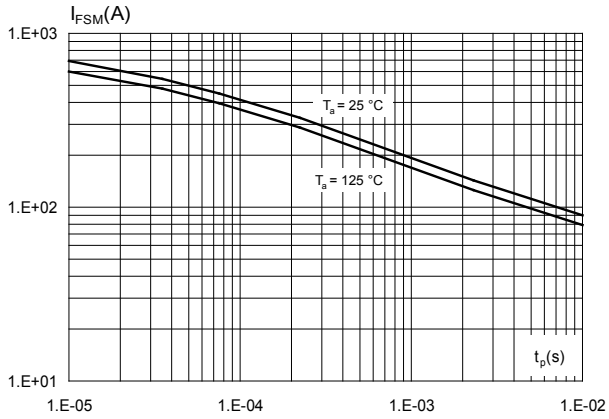
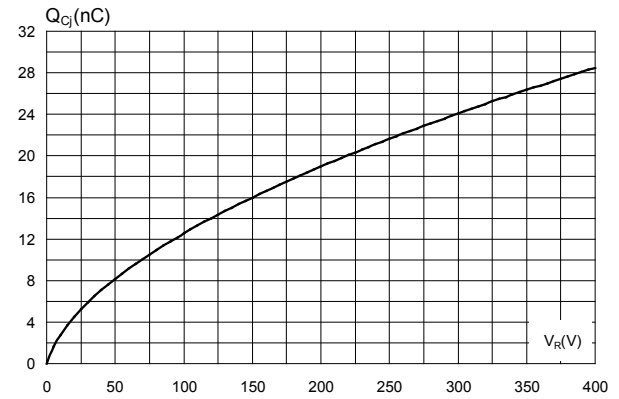
1.1 Characteristics (curves)
Figure 1. Forward voltage drop versus forward current (typical values, low level)

Figure 2. Forward voltage drop versus forward current (typical values, high level)

Figure 3. Reverse leakage current versus reverse voltage applied (typical values)

Figure 4. Peak forward current versus case temperature

Figure 5. Junction capacitance versus reverse voltage applied (typical values)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration


Figure 7. Non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)

Figure 8. Total capacitive charges versus reverse voltage applied (typical values)


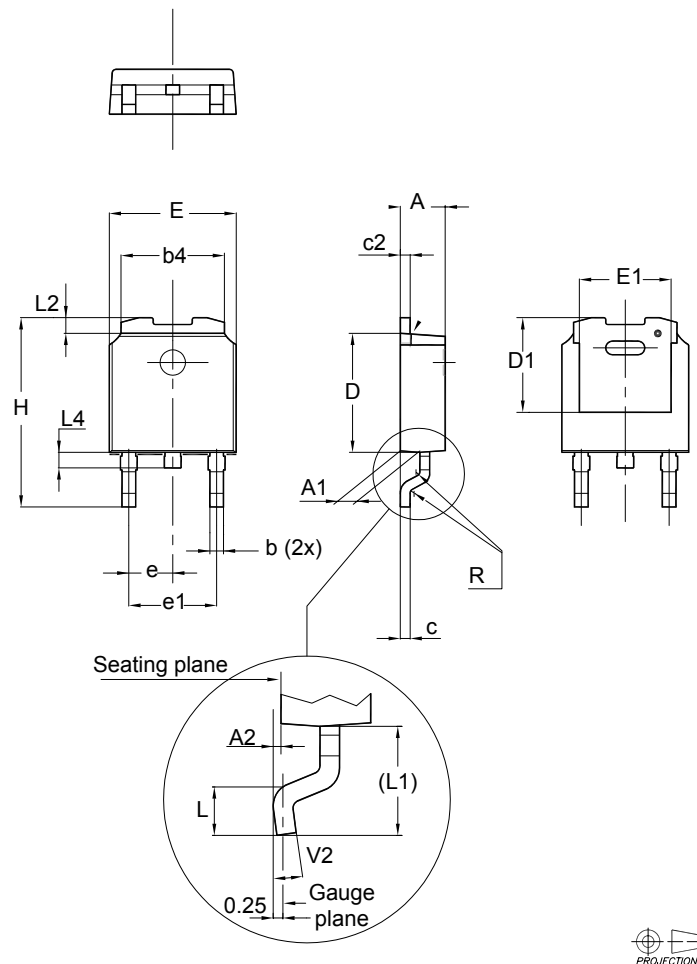
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 DPAK package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

Figure 9. DPAK package outline



3 Ordering Information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPSC10H065BY-TR	PSC10H 065BY	DPAK	0.32 g	2500	Tape and reel

Revision history

Table 7. Document revision history

Date	Version	Changes
08-Mar-2018	1	Initial release.

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